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256-Kbit (32 K × 8) Static RAM

Features

■ Very high speed: 70 ns

■ Temperature ranges:

□ Industrial: -40 °C to +85 °C

■ Wide voltage range: 1.65 V to 2.25 V

■ Pin compatible with CY62256N

■ Ultra low standby power

□ Typical standby current: 1 µA

□ Maximum standby current: 4 μA

■ Ultra low active power

□ Typical active current: 1.3 mA at f = 1 MHz

■ Easy memory expansion with CE and OE features

■ Automatic power-down when deselected

 Complementary metal oxide semiconductor (CMOS) for optimum speed and power

■ Offered in Pb-free 28-pin Narrow SOIC package

Functional Description

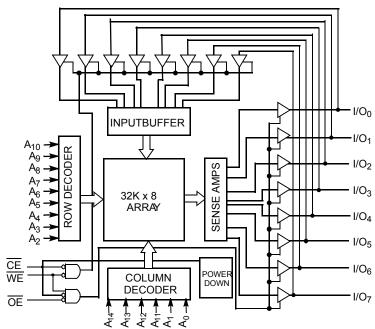
The CY62256EV18 is a high performance CMOS static RAM module organized as 32 K words by 8-bits. This device features advanced circuit design to provide ultra low active current. This is ideal for providing More Battery Life $^{\rm TM}$ (MoBL $^{\rm I\!B}$) in portable applications such as cellular telephones. The device also has an automatic power-down feature that significantly reduces power consumption when addresses are not toggling. Placing the device in standby mode reduces power consumption by more than 99 percent when deselected ($\overline{\rm CE}$ HIGH). The eight input and output pins (I/O $_{\rm 0}$ through I/O $_{\rm 7}$) are placed in a high impedance state when the device is deselected ($\overline{\rm CE}$ HIGH), the outputs are disabled ($\overline{\rm OE}$ HIGH), or a write operation is in progress ($\overline{\rm CE}$ LOW and WE LOW).

To write to the device, take chip enable (\overline{CE}) LOW and write enable (\overline{WE}) LOW. Data on the eight I/O pins is then written into the location specified on the address pin $(A_0$ through $A_{14})$.

To read <u>from</u> the device, take chip enable $(\overline{CE} \underline{LOW})$ and output enable (\overline{OE}) LOW while forcing write enable (\overline{WE}) HIGH. Under these conditions, the contents of the memory location specified by the address pins appear on the I/O pins.

For a complete list of related documentation, click here.

Logic Block Diagram







Contents

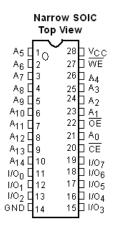
Pin Configuration	3
Product Portfolio	
Maximum Ratings	
Operating Range	
Electrical Characteristics	
Capacitance	
Thermal Resistance	
AC Test Loads and Waveforms	5
Data Retention Characteristics	6
Data Retention Waveform	
Switching Characteristics	
Switching Waveforms	
Truth Table	

Ordering information	11
Ordering Code Definitions	11
Package Diagrams	12
Acronyms	13
Document Conventions	13
Units of Measure	13
Document History Page	14
Sales, Solutions, and Legal Information	15
Worldwide Sales and Design Support	15
Products	15
PSoC® Solutions	15
Cypress Developer Community	15
Technical Support	



Pin Configuration

Figure 1. 28-pin Narrow SOIC pinout



Product Portfolio

				_ ا					Power Di	ssipation		
Product	Range	V _{CC} Range (V)		Speed (ns)	Operating I _{CC} (mA)			Standby I _{SB2} (μA)				
				(- /	f = 1 MHz f = f _{max}		max					
		Min	Typ ^[1]	Max		Typ ^[1]	Max	Typ ^[1]	Max	Typ ^[1]	Max	
CY62256EV18LL	Industrial	1.65	1.8	2.25	70	1.3	2.0	11	16	1	4	

^{1.} Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at V_{CC} = V_{CC(typ)}, T_A = 25 °C.



Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested. Storage temperature-65 °C to +150 °C Ambient temperature with Supply voltage to ground potential-0.2 V to 2.45 V DC voltage applied to outputs in high Z State $^{[2,\ 3]}$ -0.2 V to 2.45 V

DC input voltage [2, 3]	0.2 V to 2.45 V
Output current into outputs (LOW)	20 mA
Static discharge voltage (MIL-STD-883, method 3015)	> 2001 V
Latch-up current	> 200 mA

Operating Range

Device	Range	Ambient Temperature	V _{CC} ^[4]
CY62256EV18LL	Industrial	–40 °C to +85 °C	1.65 V to 2.25 V

Electrical Characteristics

Over the Operating Range

Doromotor	Description	Toot Co	nditiono		Unit		
Parameter	Description	Test Conditions		Min	Typ ^[5]	Max	Offic
V _{OH}	Output HIGH voltage	$I_{OH} = -0.1 \text{ mA}$		1.4	_	_	V
V _{OL}	Output LOW voltage	I _{OL} = 0.1 mA		_	_	0.2	V
V _{IH}	Input HIGH voltage	V _{CC} = 1.65 V to 2	.25 V	1.4	_	V _{CC} + 0.2 V	V
V _{IL}	Input LOW voltage	V _{CC} = 1.65 V to 2	.25 V	-0.2	_	0.4	V
I _{IX}	Input leakage current	$GND \le V_1 \le V_{CC}$	-1	_	+1	μΑ	
I _{OZ}	Output leakage current	GND ≤ V _O ≤ V _{CC} , output disabled		-1	_	+1	μΑ
I _{CC}	V _{CC} operating supply current	$f = f_{max} = 1/t_{RC}$	V _{CC} = 2.25 V	_	11	16	mA
		f = 1 MHz	I _{OUT} = 0 mA CMOS levels	-	1.3	2.0	mA
I _{SB1}	Automatic CE power-down current — CMOS inputs	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		-	1	4	μА
I _{SB2} ^[6]	Automatic CE power-down current — CMOS inputs	$\overline{CE} \ge V_{CC} - 0.2 \text{ V}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$ $f = 0, V_{CC} = 2.25 \text{ V}$	or $V_{IN} < 0.2 V$,	-	1	4	μА

- $V_{IL(min)}$ = -2.0 V for pulse durations less than 20 ns.

- 2. V_{IL(min)} = V_{CC} + 0.5 V for pulse durations less than 20 ns.

 3. V_{IH(max)} = V_{CC} + 0.5 V for pulse durations less than 20 ns.

 4. Full device AC operation assumes a 100 µs ramp time from 0 to V_{CC(min)} and 200 µs wait time after V_{CC} stabilization.

 5. Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at V_{CC} = V_{CC(typ)}, T_A = 25 °C.
- 6. Chip enables (CE) must be at CMOS level to meet the I_{SB2} / I_{CCDR} spec. Other inputs can be left floating.



Capacitance

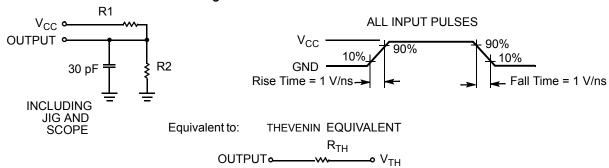
Parameter [7]	Description	Test Conditions	Max	Unit
C _{IN}	Input capacitance	$T_A = 25 ^{\circ}\text{C}, f = 1 \text{MHz}, V_{CC} = V_{CC(typ)}$	10	pF
C _{OUT}	Output capacitance		10	pF

Thermal Resistance

Parameter [7]	Description	Test Conditions	28-pin SOIC	Unit
U/A	Thermal resistance (junction to ambient)	Still air, soldered on a 3 × 4.5 inch, two-layer printed circuit board	76.56	°C/W
$\Theta_{\sf JC}$	Thermal resistance (junction to case)		36.07	°C/W

AC Test Loads and Waveforms

Figure 2. AC Test Loads and Waveforms



Parameters	1.8 V	Unit
R1	13500	Ω
R2	10800	Ω
R _{TH}	6000	Ω
V _{TH}	0.8	V

Note

Tested initially and after any design or process changes that may affect these parameters.



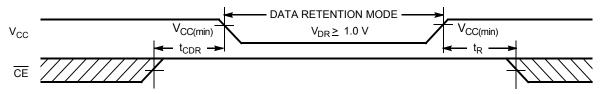
Data Retention Characteristics

Over the Operating Range

Parameter	Description	Conditions	Min	Typ ^[8]	Max	Unit
V_{DR}	V _{CC} for data retention		1.0	-	-	V
I _{CCDR} ^[9]	Data retention current	$V_{CC} = 1.0 \text{ V}, \overline{CE} \ge V_{CC} - 0.2 \text{ V}, \ V_{IN} \ge V_{CC} - 0.2 \text{ V or } V_{IN} \le 0.2 \text{ V}$	_	_	3	μA
t _{CDR} ^[10]	Chip deselect to data retention time		0	_	_	ns
t _R ^[11]	Operation recovery time		70	_	-	ns

Data Retention Waveform

Figure 3. Data Retention Waveform [12]



- 8. Typical values <u>are</u> included for reference only and are not guaranteed or tested. Typical values are measured at V_{CC} = V_{CC(typ)}, T_A = 25 °C.
 9. Chip enables (CE) must be at CMOS level to meet the I_{SB2} / I_{CCDR} spec. Other inputs can be left floating.

- 10. Tested initially and after any design or process changes that may affect these parameters.

 11. Full device AC operation requires linear V_{CC} ramp from V_{DR} to V_{CC(min)} ≥ 100 μs or stable at V_{CC(min)} ≥ 100 μs.

 12. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.



Switching Characteristics

Over the Operating Range

Parameter [13]	Description		ns	I I mit
Parameter [19]	Description	Min	Max	Unit
Read Cycle				•
t _{RC}	Read cycle time	70	_	ns
t _{AA}	Address to data valid	_	70	ns
t _{OHA}	Data hold from address change	5	_	ns
t _{ACE}	CE LOW to data valid	_	70	ns
t _{DOE}	OE LOW to data valid	_	35	ns
t _{LZOE}	OE LOW to low Z [14]	5	_	ns
t _{HZOE}	OE HIGH to high Z [14, 15]	_	25	ns
t _{LZCE}	CE LOW to low Z [14]	5	_	ns
t _{HZCE}	CE HIGH to high Z [14, 15]	_	25	ns
t _{PU}	CE LOW to power-up	0	_	ns
t _{PD}	CE HIGH to power-down	_	70	ns
Write Cycle [16	, 17]			•
t _{WC}	Write cycle time	70	_	ns
t _{SCE}	CE LOW to write end	60	_	ns
t _{AW}	Address setup to write end	60	_	ns
t _{HA}	Address hold from write end	0	_	ns
t _{SA}	Address setup to write start	0	_	ns
t _{PWE}	WE pulse width	50	_	ns
t _{SD}	Data setup to write end	30	_	ns
t _{HD}	Data hold from write end	0	_	ns
t _{HZWE}	WE LOW to high Z [14, 15]	_	25	ns
t _{LZWE}	WE HIGH to low Z [14]	5	_	ns

Notes

13. Test Conditions for all parameters other than tri-state parameters assume signal transition time of 3 ns or less (1 V/ns), timing reference levels of V_{CC(typ)}/2, input pulse levels of 0 to V_{CC(typ)}, and output loading of the specified I_{OL}/I_{OH} as shown in the Figure 2 on page 5.

14. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZCE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.

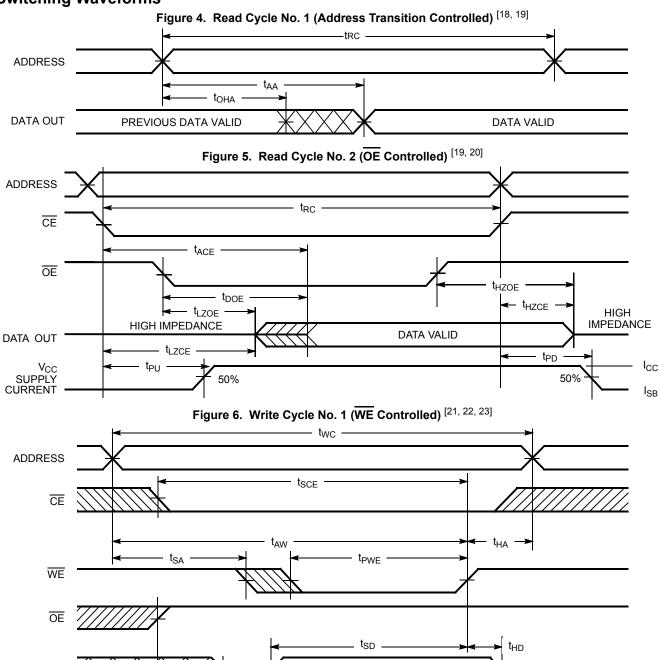
15. t_{HZCE}, t_{HZCE}, and t_{HZWE} transitions are measured when the outp<u>ut enter</u> a high impedance state.

16. The internal write time of the memory is defined by the overlap of WE, CE = V_{IL}. All signals must be ACTIVE to initiate a write and any of these signals can terminate a write by going INACTIVE. The data input setup and hold timing should be referenced to the edge of the signal that terminates the write.

17. The minimum write cycle pulse width for Write Cycle No. 3 (WE Controlled, OE low) should be equal to the sum of t_{SD} and t_{HZWE}.



Switching Waveforms



18. The device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.

NOTE 24

19. WE is HIGH for read cycle.

DATA I/O

- 20. Address valid before or similar to $\overline{\text{CE}}$ transition LOW.
- 21. The internal write time of the memory is defined by the overlap of $\overline{\text{WE}}$, $\overline{\text{CE}} = \text{V}_{\text{IL}}$. All signals must be ACTIVE to initiate a write and any of these signals can terminate a write by going INACTIVE. The data input setup and hold timing should be referenced to the edge of the signal that terminates the write.

DATA VALID

- 22. Data I/O is high impedance if $\overline{OE} = V_{|H-}$ 23. If \overline{CE} goes HIGH simultaneously with WE HIGH, the output remains in high impedance state.
 24. During this period, the I/Os are in output state. Do not apply input signals.



Switching Waveforms (continued)

Figure 7. Write Cycle No. 2 (CE Controlled) [25, 26, 27]

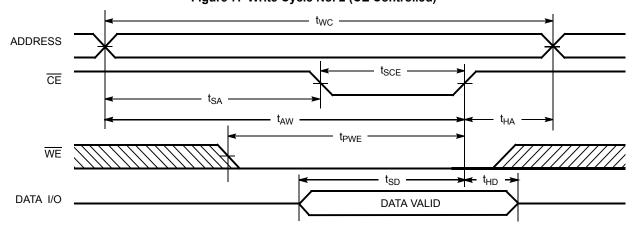
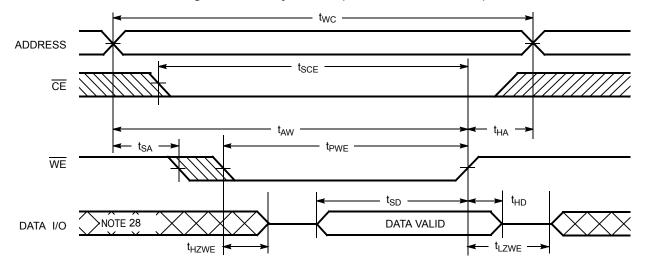


Figure 8. Write Cycle No. 3 (WE Controlled, OE LOW) [27]



^{25.} The internal write time of the memory is defined by the overlap of WE, CE = V_{IL}. All signals must be ACTIVE to initiate a write and any of these signals can terminate a write by going INACTIVE. The data input setup and hold timing should be referenced to the edge of the signal that terminates the write.

^{26.} Data I/O is high impedance if \overline{OE} = $V_{|H:}$ 27. If \overline{CE} goes HIGH simultaneously with \overline{WE} HIGH, the output remains in high impedance state.

^{28.} During this period, the I/Os are in output state. Do not apply input signals.



Truth Table

CE	WE	ŌĒ	Inputs/Outputs	Mode	Power
Н	X ^[29]	X ^[29]	High Z	Deselect/power-down	Standby (I _{SB})
L	Н	L	Data out	Read	Active (I _{CC})
L	L	X ^[29]	Data in	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, outputs disabled	Active (I _{CC})

29. The 'X' (Don't care) state for the $\overline{\text{CE}}$ / $\overline{\text{OE}}$ / $\overline{\text{WE}}$ in the truth table refer to the logic state (either HIGH or LOW). Intermediate voltage levels on these pins is not permitted.

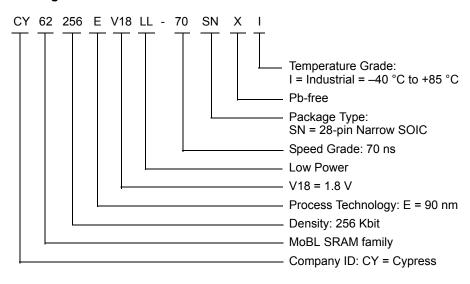


Ordering Information

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
70	CY62256EV18LL-70SNXI	51-85092	28-pin (300-Mil) Narrow SOIC (Pb-free)	Industrial

Contact your local Cypress sales representative for availability of these parts.

Ordering Code Definitions

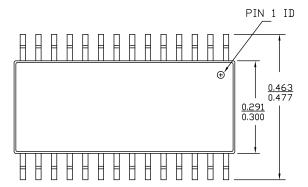


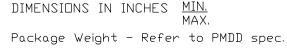


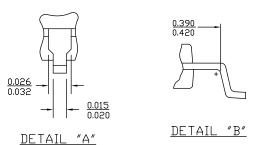
Package Diagrams

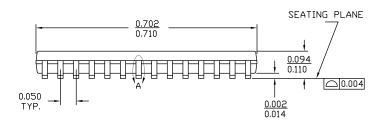
Figure 9. 28-pin SNC (300 Mils) SN28.3 (Narrow Body) Package Outline, 51-85092

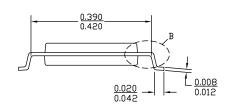
SNC 28.300 WITH NARROW BODY











51-85092 *E



Acronyms

Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
CE	Chip Enable			
I/O	Input/Output			
OE	Output Enable			
SRAM	Static Random Access Memory			
SOIC	Small Outline Integrated Circuit			
WE	Write Enable			

Document Conventions

Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
MHz	megahertz
μΑ	microampere
μs	microsecond
mA	milliampere
ns	nanosecond
Ω	ohm
pF	picofarad
V	volt
W	watt



Document History Page

Revision	ECN	Submission Date	Orig. of Change	Description of Change
**	3334904	09/07/2011	RAME	New data sheet.
*A	3413173	10/18/2011	RAME	Changed status from Preliminary to Final.
*B	3733339	09/04/2012	JISH	Fixed typo errors. Completing Sunset Review.
*C	4573121	11/18/2014	JISH	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end.
*D	4928585	09/21/2015	VINI	Updated Switching Characteristics: Added Note 17 and referred the same note in "Write Cycle". Updated to new template. Completing Sunset Review.



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